# BGA Heat Sink - High Performance maxiFLOW w/Thermal Tape





ATS Part#:

Description:

#### ATS-52330P-C1-R0

33.00 x 33.00 x 17.50 mm BGA Heat Sink - High Performance maxiFLOW w/Thermal Tape

Heat Sink Type:maxiFLOWHeat Sink Attachment:Thermal TapeEquivalent Part Number:ATS-52330P-C2-R0

\*Image above is for illustration purpose only.

#### **Features & Benefits**

- maxiFLOW<sup>™</sup> design features a low profile, spread fin array that maximizes surface area for more effective convection (air) cooling
- Fabricated from extruded aluminum, which minimizes thermal resistance from the base to the fins, reduces weight and keeps costs low
- Higher performance helps ensure reliable product life at a lower cost than other extruded heat sinks

#### **Thermal Performance**

		@200 LFM 1.0 M/S	@300 LFM 1.5 M/S	@400 LFM 2.0 M/S	@500 LFM 2.5 M/S	@600 LFM 3.0 M/S	@700 LFM 3.5 M/S	@800 LFM 4.0 M/S
THERMAL RESISTANCE	Unducted Flow	2.7 °C/W	2.1 °C/W	1.9 °C/W	1.7 °C/W	1.5 °C/W	1.4 °C/W	1.4 °C/W
	Ducted Flow	2.1	N/A	N/A	N/A	N/A	N/A	N/A

### **Product Detail**

Schematic Image	Dimension A	Dimension B	Dimension C	Dimension D	ТІМ	Finish
	33.00 mm	33.00 mm	17.50 mm	58.16 mm	T412	BLUE-ANODIZED
	<ul> <li>Dimension</li> <li>ATS-5233         <ul> <li>(Saint-Gol</li> <li>Thermal p application</li> <li>ATS reser performan</li> <li>ATS certifi</li> </ul> </li> </ul>	ves the right to upda	eight from the bottor act heat sink assemb provided for referer ate or change its proc k assembly is RoHS	ly with an equivalen nce only. Actual perf ducts without notice -6 and REACH com	t thermal ormance to improv	interface material may vary by
*Image above is for illustration purpose only.						

For more information, to find a distributor or to place an order, please contact us at 781-769-2800 (North America), **sales@qats.com** or **www.qats.com**.



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